NSR15SDW1T1 NSR15SDW1T2

Dual RF Schottky Diode

These diodes are designed for analog and digital applications, including DC based signal detection and mixing applications.

Features

- Low Capacitance (<1 pF)
- Low V_F (390 mV typical @ 1 mA)
- Low V_F (1 mV typical @ 1 mA)
- Pins 2 and 5 Shorted
- Pb-Free Packages are Available

Benefits

- Reduced Parasitic Losses
- Accurate Signal Measurement
- Reduced Cross Talk

MAXIMUM RATINGS

Rating	Symbol	Max	Unit		
Peak Reverse Voltage	V_R	15	V		
Forward Current	lF	30	mA		
Operating and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C		
ESD Rating: Class 1 per Human Body Model					

ESD Rating: Class 1 per Human Body Model Class A per Machine Model

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit	
Maximum Thermal Resistance Junction–to–Ambient	$R_{ hetaJA}$	500	°C/W	

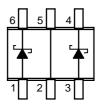
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



ON Semiconductor®

http://onsemi.com

RF SCHOTTKY BARRIER DIODES 15 VOLTS, 30 mA





SC-88 CASE 419B STYLE 21

MARKING DIAGRAM



R6 = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

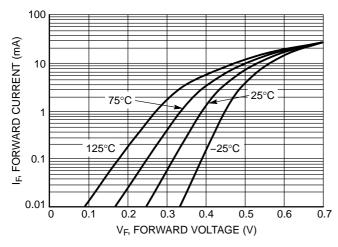
Device	Package	Shipping [†]
NSR15SDW1T1	SC-88	3000/Tape & Reel
NSR15SDW1T1G	SC-88 (Pb-Free)	3000/Tape & Reel
NSR15SDW1T2	SC-88	3000/Tape & Reel
NSR15SDW1T2G	SC-88 (Pb-Free)	3000/Tape & Reel
NSR15SDW1T4	SC-88	10,000/Tape & Reel
NSR15SDW1T4G	SC-88 (Pb-Free)	10,000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSR15SDW1T1 NSR15SDW1T2

ELECTRICAL CHARACTERISTICS

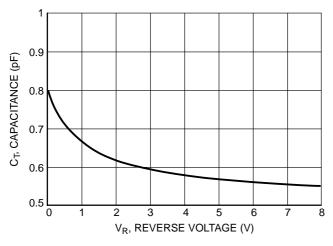
Characteristic	Symbol	Min	Тур	Max	Unit
Breakdown Voltage ($I_R = 10 \mu A$)	V_{BR}	15	20	_	V
Reverse Leakage (V _R = 1 V)	I _R	_	2	50	nA
Forward Voltage (I _F = 1 mA)	V _{F1}	_	390	415	mV
Forward Voltage (I _F = 10 mA)	V _{F2}	_	530	680	mV
Delta V _F (I _F = 1 mA, All Diodes)	ΔV_F	_	1	15	mV
Capacitance (V _F = 0 V, f = 1 MHz)	C _T	_	0.8	1	pF



100 k (V) 10 k 100 k 125°C 100 k 125°C 100 k 125°C 100 k 100 k

Figure 1. Forward Current versus Forward Voltage at Temperatures

Figure 2. Reverse Current versus Reverse Voltage



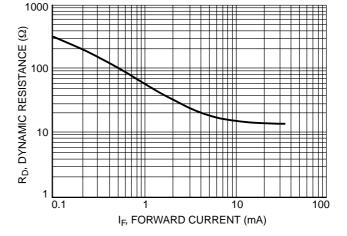


Figure 3. Total Capacitance versus Reverse Voltage

Figure 4. Dynamic Resistance versus Forward Current

NSR15SDW1T1 NSR15SDW1T2

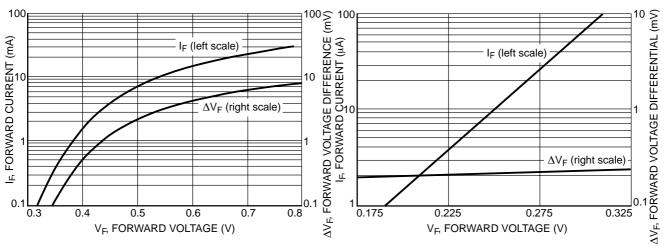


Figure 5. Typical V_F Match at Mixer Bias Levels

Figure 6. Typical V_F Match at Detector Bias Levels

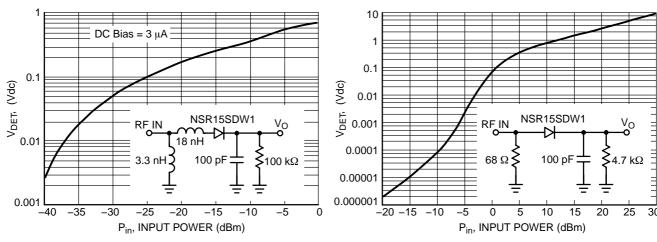


Figure 7. Typical Output Voltage versus Input Power, Small Signal Detector Operating at 850 MHz

Figure 8. Typical Output Voltage versus Input Power, Large Signal Detector Operating at 915 MHz

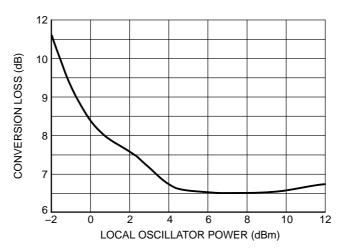


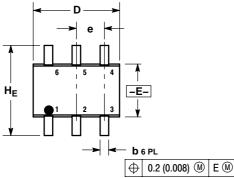
Figure 9. Typical Conversion Loss versus L.O. Drive, 2.0 GHz

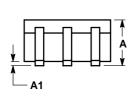
NSR15SDW1T1 NSR15SDW1T2

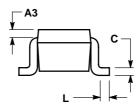
PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02

ISSUE W







NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH
- 419B-01 OBSOLETE, NEW STANDARD 419B-02.

	MIL	LIMETE	ERS	INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.20 REF			0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012
С	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	2.00	2.10	2.20	0.078	0.082	0.086

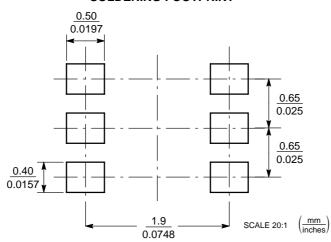
STYLE 21:

- PIN 1. ANODE 1 2. N/C

 - 3. ANODE 2 4. CATHODE 2

 - 5. N/C

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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